

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT application of: CM

) Art Unit: 2822

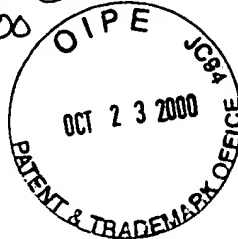
Ohtani et al. 10/20/00

) Examiner: Evan T. PERT

Serial No. 08/807,737

Filed: February 27, 1997

For: METHOD FOR MANUFACTURING
SEMICONDUCTOR DEVICE



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Susan J. Stilbs

AMENDMENT

Honorable Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

In response to the Office Action dated June 22, 2000, please amend the above-identified application and consider Applicant's remark as follows.

IN THE SPECIFICATION:

Please amend the specification as follows:

On page 6, line 17, after "absence of " insert -- a--.

On page 28, line 26, change "rational speed" to -- rotational speed--.

IN THE CLAIMS:

Please amend the Claims 36 and 74 as follows:

36. (Amended) A method of manufacturing a semiconductor device comprising the steps of:

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contd

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